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# SPDT NON-REFLECTIVE SWITCH, DC - 4 GHz

### **Typical Applications**

The HMC435AMS8G(E) is ideal for:

- Basestations & Repeaters
- Cellular/3G and WiMAX/4G
- Infrastructure and Access Points
- CATV/CMTS
- Test Instrumentation

#### **Features**

High Isolation: 62 dB @ 1 GHz

52 dB @ 2 GHz

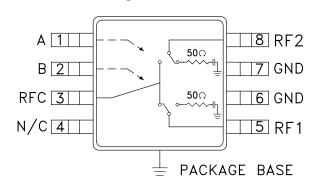
Single Positive Control: 0/+5V

Input IP3: 54 dBm

Non-Reflective Design

Ultra Small MSOP-86 Package: 14.8 mm<sup>2</sup>

### **Functional Diagram**



### **General Description**

The HMC435AMS8G(E) is a non-reflective DC to 4 GHz GaAs MESFET SPDT switch in a low cost 8 lead MSOP8G surface mount package with exposed ground paddle. The switch is ideal for cellular/3G and WiMAX/4G applications yielding up to 60 dB isolation, low 0.8 dB insertion loss and +50 dBm input IP3. Power handling is excellent up through the 3.8 GHz WiMAX band with the switch offering a P1dB compression of +30 dBm. On-chip circuitry allows positive voltage control of 0/+5 Volts at very low DC currents.

### Electrical Specifications, $T_A = +25^{\circ}$ C, Vctl = 0/+5 Vdc, 50 Ohm System

Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 2.5 GHz DC - 3.6 GHz DC - 4.0 GHz		0.8 1.0 1.2	1.0 1.5 1.8	dB dB dB
Isolation (RFC to RF1/RF2)	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.6 GHz DC - 4.0 GHz	56 46 43 37 30	62 52 48 42 40		dB dB dB dB dB
Return Loss (On State)	DC - 2.5 GHz DC - 3.6 GHz DC - 4.0 GHz	15 13 11	23 17 14		dB dB dB
Return Loss (Off State)	0.5 - 4.0 GHz	16	21		dB
Input Power for 1 dB Compression	0.5 - 4.0 GHz	27	30		dBm
Input Third Order Intercept (Two-Tone Input Power = +7 dBm Each Tone)	0.5 - 1.0 GHz 0.5 - 2.5 GHz 0.5 - 4.0 GHz	48 45 41	54 53 51		dBm dBm dBm
Switching Speed	DC - 4.0 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)			40 60		ns ns

# **HMC435A\* PRODUCT PAGE QUICK LINKS**

Last Content Update: 12/18/2017

# COMPARABLE PARTS 🖳

View a parametric search of comparable parts.

### **EVALUATION KITS**

HMC435AMS8G Evaluation Board

### **DOCUMENTATION**

#### **Data Sheet**

• HMC435A Data Sheet

### **TOOLS AND SIMULATIONS**

HMC435A S-Parameters

# REFERENCE MATERIALS 🖵

#### **Product Selection Guide**

 RF, Microwave, and Millimeter Wave IC Selection Guide 2017

#### **Quality Documentation**

Semiconductor Qualification Test Report: PHEMT-J (QTR: 2013-00285)

# **DESIGN RESOURCES**

- HMC435A Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

### **DISCUSSIONS**

View all HMC435A EngineerZone Discussions.

### SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

## **TECHNICAL SUPPORT**

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK $\Box$

Submit feedback for this data sheet.

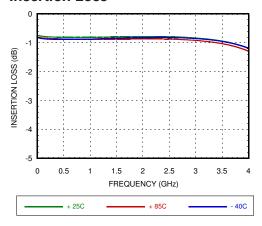


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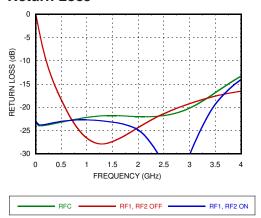


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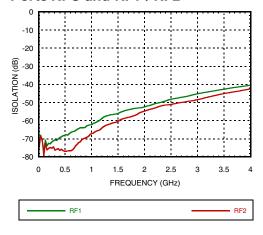
#### **Insertion Loss**



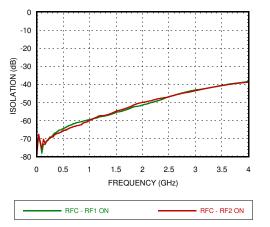
#### **Return Loss**



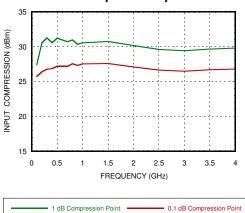
# Isolation Between Ports RFC and RF1 / RF2



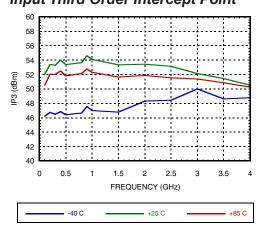
#### Isolation Between Ports RF1 and RF2



### 0.1 and 1 dB Input Compression Point



### Input Third Order Intercept Point





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### **Absolute Maximum Ratings**

Control Voltage Range	-0.5 to +7.5 Vdc
RF Input Power VctI = 0/+5V	+31 dBm
RF1, RF2 Termination	+26 dBm
Junction Temperature	150 °C
Insertion Loss Path - (channel to ground) Continuous Pdiss (T = 85 °C) (derate 13 mW/°C above 85 °C)	0.86 W
Thermal Resistance	75 °C/W
Termination Path - (channel to ground)  Continuous Pdiss (T = 85 °C)  (derate 6.5 mW/°C above 85 °C)	0.42 W
Thermal Resistance	153 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

### **Control Voltages**

\*Control Input Tolerances are ± 0.2 Vdc

State	Bias Condition*	
Low	0 Vdc @ 5 μA Typical	
High	+5.0 Vdc @ 5 μA Typical	

#### **Truth Table**

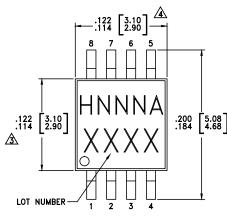
Control Input		Signal Path State
Α	В	RFC to:
Low	High	RF1
High	Low	RF2

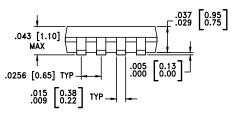
DC blocks are required at ports RFC, RF1, RF2.

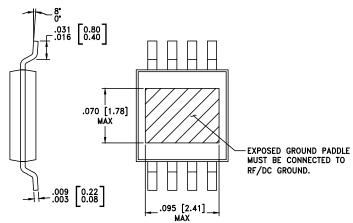
Do not operate continuously at RF power input greater than 1 dB compression and do not "*Hot Switch*" power levels greater than +24 dBm (control = 0/+5 Vdc).



### **Outline Drawing**







#### NOTES:

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND



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### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC435AMS8G	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H435A XXXX
HMC435AMS8GE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H435A XXXX

- [1] Max peak reflow temperature of 235  $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260  $^{\circ}$ C
- [3] 4-Digit lot number XXXX

### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1	А	See truth and control voltage tables.	R
2	В	See truth and control voltage tables.	<u> </u>
3, 5, 8	RFC, RF1, RF2	These pins are DC coupled and matched to 50 Ohms. Blocking capacitors are required.	
4	N/C	This pin is not connected internally; however, all data shown herein was measured with this pin connected to RF/DC ground externally.	
6, 7	GND	Package bottom has exposed metal paddle that must be connected to PCB RF ground as well.	→ GND —

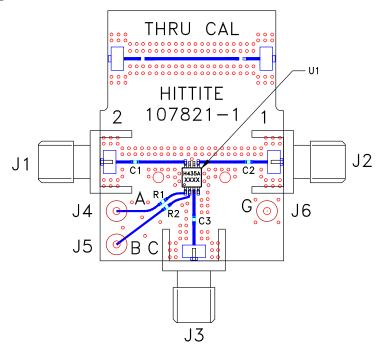


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# SPDT NON-REFLECTIVE SWITCH, DC - 4 GHz

#### **Evaluation PCB**



### List of Materials for Evaluation PCB EVAL 105143-HMC435AMS8G[1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4 - J6	DC Pin
C1 - C3	100 pF Capacitor, 0402 Pkg.
R1 - R2	100 Ohm Resistor, 0402 Pkg.
U1	HMC435AMS8G(E) SPDT Switch
PCB [2]	107821 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 Ohm impedance and the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.